

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at www.onsemi.com

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, emplo



February 2009

74LVXC3245

8-Bit Dual Supply Configurable Voltage Interface Transceiver with 3-STATE Outputs

Features

- Bidirectional interface between 3V and 3V-to-5V buses
- Control inputs compatible with TTL level
- Outputs source/sink up to 24 mA
- Guaranteed simultaneous switching noise level and dynamic threshold performance
- Implements proprietary EMI reduction circuitry
- Flexible V_{CCB} operating range
- Allows B Port and V_{CCB} to float simultaneously when OE
- Functionally compatible with the 74 series 245

General Description

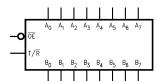
The LVXC3245 is a 24-pin dual-supply, 8-bit configurable voltage interface transceiver suited for PCMCIA and other real time configurable I/O applications. The $V_{\rm CCA}$ pin accepts a 3V supply level. The A Port is a dedicated 3V port. The $V_{\rm CCB}$ pin accepts a 3V-to-5V supply level. The B Port is configured to track the $V_{\rm CCB}$ supply level respectively. A 5V level on the $V_{\rm CC}$ pin will configure the I/O pins at a 5V level and a 3V $V_{\rm CC}$ will configure the I/O pins at a 3V level. The A Port should interface with a 3V host system and the B Port to the card slots. This device will allow the $V_{\rm CCB}$ voltage source pin and I/O pins on the B Port to float when $\overline{\rm OE}$ is HIGH. This feature is necessary to buffer data to and from a PCMCIA socket that permits PCMCIA cards to be inserted and removed during normal operation.

Ordering Code:

Order Number	Package Number	Package Description
74LVXC3245WM	M24B	224-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
74LVXC3245QSC	MQA24	24-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150" Wide
74LVXC3245MTC	MTC24	24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devices also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code

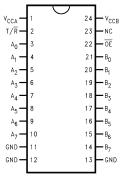
Logic Symbol/s



Pin Descriptions

Pin Names	Description
ŌE	Output Enable Input
T/R	Transmit/Receive Input
A ₀ -A ₇	Side A Inputs or 3-STATE Outputs
B ₀ –B ₇	Side B Inputs or 3-STATE Outputs

Connection Diagram/s

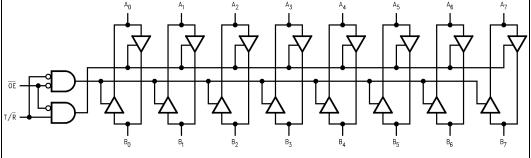


Truth Table/s

Inp	outs	Outputs
OE	T/R	
L	L	Bus B Data to Bus A
L	Н	Bus A Data to Bus B
Н	X	HIGH-Z State

- H = HIGH Voltage Level L = LOW Voltage Level X = Immaterial

Logic Diagram/s



Absolute Maximum Ratings(Note 1)

-0.5V to +7.0V Supply Voltage (V_{CCA} , V_{CCB}) DC Input Voltage (V_I) @ $\overline{\text{OE}}$, T/ $\overline{\text{R}}$ -0.5V to V_{CCA} +0.5V

DC Input/Output Voltage (V_{I/O})

-0.5V to V_{CCA} +0.5V@ A_n @ B_n -0.5V to V_{CCB} +0.5V

DC Input Diode Current (I_{IK})

@ OE, T/R ±20 mA DC Output Diode (I_{OK}) Current ±50 mA DC Output Source or Sink Current (IO) $\pm 50~\text{mA}$

DC V_{CC} or Ground Current

per Output Pin (I_{CC} or I_{GND}) $\pm 50 \ mA$ and Max Current ±200 mA -65°C to +150°C

Storage Temperature Range (T_{STG})

DC Latch-Up Source or Sink Current

Recommended Operating Conditions (Note 2)

Supply Voltage

2.7V to 3.6V V_{CCA} 3.0V to 5.5V V_{CCB} Input Voltage (V_I) @ OE, T/R 0V to V_{CCA}

Input Output Voltage (V_{I/O})

@ A_n 0V to V_{CCA} @ B_n 0V to $V_{\mbox{\scriptsize CCB}}$ Free Air Operating Temperature (T_A) -40°C to +85°C Minimum Input Edge Rate (Δt/ΔV) 8 ns/V

 $\rm V_{IN}$ from 30% to 70% of $\rm V_{CC}$

V_{CC} @ 3.0V, 4.5V, 5.5V

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The A Port unused pins (inputs or I/Os) must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter		V _{CCA}	V _{CCB}	$T_A =$	25°C	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	Units	Conditions
Cymbol			(V)	(V)	Тур	Gua	aranteed Limits	Units	Conditions
V _{IHA}	Minimum HIGH	A _n ,	2.7	3.0		2.0	2.0		$V_{OUT} \le 0.1V$
	Level Input	OE	3.0	3.6		2.0	2.0		or
	Voltage	T/R	3.6	5.5		2.0	2.0	V	\geq V _{CC} -0.1 V
V _{IHB}	1	B _n	2.7	3.0		2.0	2.0	V	
			3.0	3.6		2.0	2.0		
			3.6	5.5		3.85	3.85		
V _{ILA}	Maximum LOW	A _n ,	2.7	3.0		0.8	0.8		$V_{OUT} \le 0.1V$
	Level Input	OE	3.0	3.6		0.8	0.8		or
	Voltage	T/R	3.6	5.5		0.8	0.8	V	\geq V _{CC} -0.1 V
V _{ILB}	1	B _n	2.7	3.0		0.8	0.8	V	
			3.0	3.6		0.8	0.8		
			3.6	5.5		1.65	1.65		
V _{OHA}	Minimum HIGH L	evel	3.0	3.0	2.99	2.9	2.9		I _{OUT} = -100 μA
	Output Voltage		3.0	3.0	2.85	2.56	2.46		$I_{OH} = -12 \text{ mA}$
			3.0	3.0	2.65	2.35	2.25	V	$I_{OH} = -24 \text{ mA}$
			2.7	3.0	2.5	2.3	2.2		$I_{OH} = -12 \text{ mA}$
			2.7	4.5	2.3	2.1	2.0		$I_{OH} = -24 \text{ mA}$
V _{OНВ}	1		3.0	3.0	2.99	2.9	2.9		$I_{OUT} = -100 \mu A$
			3.0	3.0	2.85	2.56	2.46	V	$I_{OH} = -12 \text{ mA}$
			3.0	3.0	2.65	2.35	2.25	V	$I_{OH} = -24 \text{ mA}$
			3.0	4.5	4.25	3.86	3.76		$I_{OH} = -24 \text{ mA}$
V _{OLA}	Maximum LOW L	evel	3.0	3.0	0.002	0.1	0.1		I _{OUT} = 100 μA
	Output Voltage		3.0	3.0	0.21	0.36	0.44	V	$I_{OL} = 24 \text{ mA}$
			2.7	3.0	0.11	0.36	0.44	V	$I_{OL} = 12 \text{ mA}$
			2.7	4.5	0.22	0.42	0.5		$I_{OL} = 24 \text{ mA}$
V _{OLB}	1		3.0	3.0	0.002	0.1	0.1		I _{OUT} = 100 μA
			3.0	3.0	0.21	0.36	0.44	V	$I_{OL} = 24 \text{ mA}$
			3.0	4.5	0.18	0.36	0.44		$I_{OL} = 24 \text{ mA}$
I _{IN}	Maximum Input		3.6	3.6		±0.1	±1.0		$V_I = V_{CCA}$, GND
	Leakage Current	@	3.6	5.5		±0.1	±1.0	μА	

±300 mA

DC Electrical Characteristics (Continued)

Symbol	Paramete	_	V _{CCA}	V _{CCB}	T _A =	25°C	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	Units	Conditions
Syllibol	Faramete	1	(V)	(V)	Тур	Guaranteed Limits		Units	Conditions
I _{OZA}	Maximum 3-STATE		3.6	3.6		±0.5	±5.0		$V_I = V_{IL}, V_{IH},$
	Output Leakage		3.6	5.5		±0.5	±5.0	μΑ	OE = V _{CCA}
	@ A _n								$V_O = V_{CCA}$, GND
I _{OZB}	Maximum 3-STATE		3.6	3.6		±0.5	±5.0		$V_I = V_{IL}, V_{IH},$
	Output Leakage		3.6	5.5		±0.5	±5.0	μΑ	$\overline{OE} = V_{CCA}$
	@ B _n								$V_O = V_{CCB}$, GND
ΔI_{CC}	Maximum	B _n	3.6	5.5	1.0	1.35	1.5	mA	$V_I = V_{CCB} - 2.1V$
	I _{CC} /Input	All Inputs	3.6	3.6		0.35	0.5	IIIA	$V_I = V_{CC} - 0.6V$
I _{CCA1}	Quiescent V _{CCA}								$A_n = V_{CCA}$ or GND
	Supply Current		3.6	Open		5	50	μΑ	$B_n = Open, \overline{OE} = V_{CCA},$
	as B Port Floats								$T/\overline{R} = V_{CCA}, V_{CCB} =$ Open
I _{CCA2}	Quiescent V _{CCA}		3.6	3.6		5	50		$A_n = V_{CCA}$ or GND,
	Supply Current		3.6	5.5		5	50	μΑ	$B_n = V_{CCB}$ or GND,
									$\overline{OE} = GND, T/\overline{R} = GND$
I _{CCB}	Quiescent V _{CCB}		3.6	3.6		5	50		$A_n = V_{CCA}$ or GND,
	Supply Current		3.6	5.5		8	80	μΑ	$B_n = V_{CCB}$ or GND,
									$\overline{OE} = GND, T/\overline{R} = V_{CCA}$
V _{OLPA}	Quiet Output		3.3	3.3		0.8		V	(Note 3)(Note 4)
	Maximum Dynamic		3.3	5.0		0.8		•	
V_{OLPB}	V _{OL}		3.3	3.3		0.8		V	(Note 3)(Note 4)
			3.3	5.0		1.5		•	
V _{OLVA}	Quiet Output		3.3	3.3		-0.8		V	(Note 3)(Note 4)
	Minimum Dynamic		3.3	5.0		-0.8		•	
V _{OLVB}	V_{OL}		3.3	3.3		-0.8		V	(Note 3)(Note 4)
			3.3	5.0		-1.2		•	
V_{IHDA}	Minimum HIGH		3.3	3.3		2.0		V	(Note 3)(Note 5)
	Level Dynamic		3.3	5.0		2.0		•	
V _{IHDB}	Input Voltage		3.3	3.3		2.0		V	(Note 3)(Note 5)
			3.3	5.0		3.5		-	
V_{ILDA}	Maximum LOW		3.3	3.3		0.8		V	(Note 3)(Note 5)
	Level Dynamic		3.3	5.0		0.8		•	
V_{ILDB}	Input Voltage		3.3	3.3		0.8		V	(Note 3)(Note 5)
			3.3	5.0		1.5		-	

Note 3: Worst case package.

 $\textbf{Note 4:} \ \text{Max number of outputs defined as (n). Data inputs are driven 0V to V}_{\text{CC}} \ \text{level; one output at GND.}$

Note 5: Max number of Data Inputs (n) switching. (n–1) inputs switching 0V to V_{CC} level. Input-under-test switching: V_{CC} level to threshold (V_{IHD}) , 0V to threshold (V_{ILD}) , f = 1 MHz.

AC Electrical Characteristics

		$T_A = +25^{\circ}C$		$T_{A} = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $C_{L} = 50 \text{ pF}$ $V_{CCA} = 2.7\text{V} - 3.6\text{V}$ $V_{CCB} = 4.5\text{V} - 5.5\text{V}$		$T_{A} = +25^{\circ}\text{C}$ $C_{L} = 50 \text{ pF}$ $V_{CCA} = 2.7V - 3.6V$ $V_{CCB} = 3.0V - 3.6V$			$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $C_L = 50 \text{ pF}$ $V_{CCA} = 2.7V - 3.6V$ $V_{CCB} = 3.0V - 3.6V$		Units	
		$C_L = 50 \text{ pF}$ $V_{CCA} = 2.7V - 3.6V$ $V_{CCB} = 4.5V - 5.5V$										
Symbol	Parameter											
Syllibol	Farameter										Ullits	
		Min	Тур	Max	Min	Max	Min	Тур	Max	Min	Max	
			(Note 6)					(Note 7)				
t _{PHL}	Propagation Delay	1.0	4.8	8.0	1.0	8.5	1.0	5.5	8.5	1.0	9.0	ns
t _{PLH}	A to B	1.0	3.9	6.5	1.0	7.0	1.0	5.2	8.0	1.0	8.5	110
t _{PHL}	Propagation Delay	1.0	3.8	6.5	1.0	7.0	1.0	4.4	7.0	1.0	7.5	ns
t _{PLH}	B to A	1.0	4.3	7.5	1.0	8.0	1.0	5.1	7.5	1.0	8.0	113
t _{PZL}	Output Enable Time	1.0	4.7	8.0	1.0	8.5	1.0	6.0	9.0	1.0	9.5	ns
t _{PZH}	OE to B	1.0	4.8	8.5	1.0	9.0	1.0	6.1	9.5	1.0	10.0	113
t _{PZL}	Output Enable Time	1.0	5.9	9.5	1.0	10.0	1.0	6.4	10.0	1.0	10.5	ns
t _{PZH}	OE to A	1.0	5.4	9.0	1.0	9.5	1.0	5.8	9.0	1.0	9.5	110
t _{PHZ}	Output Disable Time	1.0	4.0	8.0	1.0	8.5	1.0	6.3	9.5	1.0	10.0	ns
t _{PLZ}	OE to B	1.0	3.8	7.5	1.0	8.0	1.0	4.5	8.0	1.0	8.5	113
t _{PHZ}	Output Disable Time	1.0	4.6	9.5	1.0	10.0	1.0	5.2	9.5	1.0	10.0	ns
t _{PLZ}	OE to A	1.0	3.1	6.5	1.0	7.0	1.0	3.4	6.5	1.0	7.0	110
t _{OSHL}	Output to Output											
toslh	Skew (Note 8)		1.0	1.5		1.5		1.0	1.5		1.5	ns
	Data to Output											

Note 6: Typical values at $V_{CCA} = 3.3V$, $V_{CCB} = 5.0V$ @ $25^{\circ}C$.

Note 7: Typical values at $V_{CCA} = 3.3V$, $V_{CCB} = 3.3V$ @ 25°C.

Note 8: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}). Parameter guaranteed by design.

Capacitance

Symbol	Parameter		Тур	Units	Conditions
C _{IN}	Input Capacitance		4.5	pF	V _{CC} = Open
C _{I/O}	Input/Output Capacitance		10	pF	$V_{CCA} = 3.3V$
					V _{CCB} = 5.0V
C _{PD}	ower Dissipation A→B		50	pF	V _{CCB} = 5.0V
	Capacitance (Note 9) B→A		40	pF	V _{CCA} = 3.3V

Note 9: C_{PD} is measured at 10 MHz.

Power Up Considerations

To insure the system does not experience unnecessary $I_{\rm CC}$ current draw, bus contention, or oscillations during power up, the following guidelines should be adhered to (refer to Table 1):

- Power up the control side of the device first. This is the $V_{\mbox{\scriptsize CCA}}$ side.
- OE should ramp with or ahead of V_{CCA}. This will help guard against bus contention.
- The Transmit/Receive control pin (T/R) should ramp with V_{CCA}, this will ensure that the A Port data pins are con-

figured as inputs. With V_{CCA} receiving power first, the A I/O Port should be configured as inputs to help guard against bus contention and oscillations.

A side data inputs should be driven to a valid logic level.
 This will prevent excessive current draw.

The above steps will ensure that no bus contention or oscillations, and therefore no excessive current draw occurs during the power up cycling of these devices. These steps will help prevent possible damage to the translator devices and potential damage to other system components.

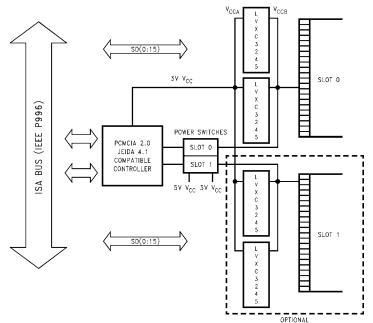
TABLE 1. Low Voltage Translator Power Up Sequencing Table

Device Type	V _{CCA}	V _{CCB}	T/R	ŌĒ	A Side I/O	B Side I/O	Floatable Pin Allowed
74LVXC3245	3V (power up 1st)	3V to 5.5V configurable	ramp with V _{CCA}	ramp with V _{CCA}	logic 0V or V _{CCA}	outputs	yes, V _{CCB} and B I/O's w/ OE HIGH

Please reference Application Note AN-5001 for more detailed information on using Fairchild's LVX Low Voltage Dual Supply CMOS Translating Transceivers.

Configurable I/O Application for PCMCIA Cards

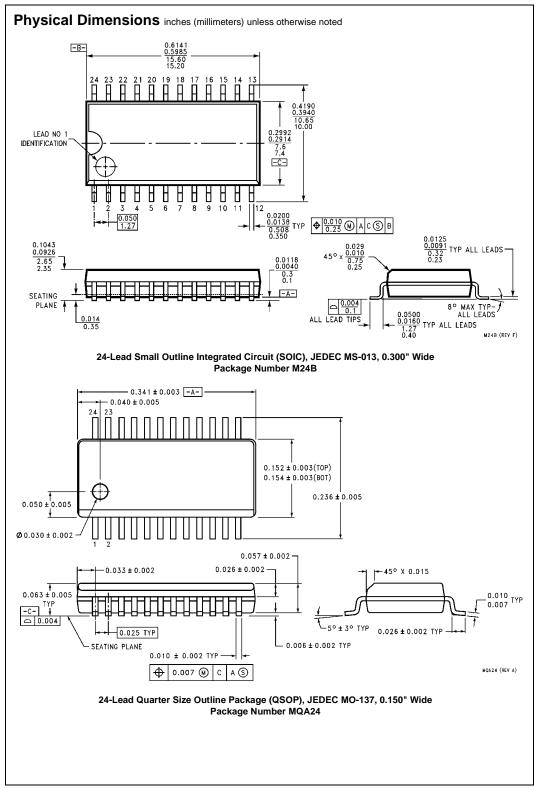
Block Diagram

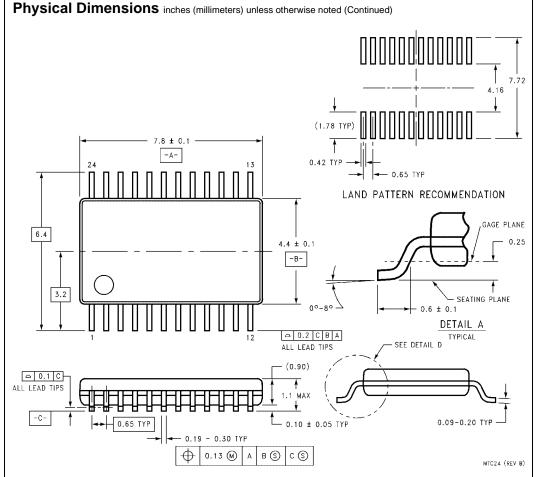


The LVXC3245 is a 24-pin dual supply device well suited for PCMCIA configurable I/O applications. Ideal for low power notebook designs, the LVXC3245 consumes less than 1 mW of quiescent power in all modes of operation. The LVXC3245 meets all PCMCIA I/O voltage requirements at 5V and 3.3V operation. By tying $\rm V_{CCB}$ of the LVXC3245 to the card voltage supply, the PCMCIA card

will always experience rail to rail output swings, maximizing the reliability of the interface.

The V_{CCA} pin on the LVXC3245 must always be tied to a 3V power supply. This voltage connection provides internal references needed to account for variations in V_{CCB} . When connected as in the figure above, the LVXC3245 meets all the voltage and current requirements of the ISA bus standard (IEEE P996).





24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC24

Fairchild does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and Fairchild reserves the right at any time without notice to change said circuitry and specifications.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks

Build it Now™ CorePLUS™ CorePOWER™ CROSSVOLT** CTL™

Current Transfer Logic™ EcoSPARK® EfficentMax™ EZSWITCH™:



Fairchild Semiconductor FACT Quiet Series™ FACT® FAST®

FastvCore^{TI} FlashWriter®

F.PESTM

FREET Global Power ResourceSM Green FPS™ Green FPS™ e-Series™ GTO™ IntelliMAX** ISOPLANAR'''

MegaBuck™ MICROCOUPLER™ MicroFET™ MicroPak™ MillerDrive™ MotionMa×™ Motion-SPM™ OPTOLOGIC⁶ OPTOPLANAR®

PDP SPM™ Power-SPM™ PowerTrench® PowerXS™ Programmable Active Droop™ QFET®

QS™ Quiet Series™ RapidConfigure™

Saving our world, 1mW/W/kW at a time™ SmartMax™

SMART START STEALTH™ SuperFET** SuperSOT**-3 SuperSOT™6 SuperSOT**-8 SupreMOS™ SyncFET™ SYSTEM ®

The Power Franchise



UHC Ultra FRFET™ UniFET™ VCX™ VisualMax™

* EZSWITCH™ and FlashWriter® are trademarks of System General Corporation, used under license by Fairchild Semiconductor

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HERRIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HERRIN, NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

- intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- Life support devices or systems are devices or systems which, (a) are 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev 138

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdt/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and exp

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800-282-9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor: